

SMD Comm COG HV, Ceramic, 100 pF, 5%, 500 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0805



Dimensions

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
T	1.25mm +/-0.15mm
S	0.75mm MIN
B	0.5mm +/-0.25mm

Packaging Specifications

Packaging:	T&R, 330mm, Plastic Tape
Packaging Quantity:	10000

General Information

Series:	SMD Comm COG HV
Style:	SMD Chip
Description:	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features:	Ultra-Stable, Low Loss, Class I
RoHS:	Yes
Termination:	Tin
Marking:	No
AEC-Q200:	No
Shelf Life:	78 Weeks
MSL:	1

Specifications

Capacitance:	100 pF
Measurement Condition:	1 MHz 1.0Vrms
Capacitance Tolerance:	5%
Voltage DC:	500 VDC
Dielectric Withstanding Voltage:	750 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor:	0.1% 1 MHz 1.0Vrms
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	100 GOhms